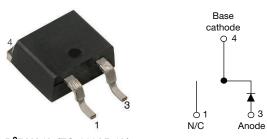


# 650 V Gen 4 Power Silicon Carbide Schottky Diode, 10 A



D<sup>2</sup>PAK 2L (TO-263AB 2L)

### **LINKS TO ADDITIONAL RESOURCES**



PRIMARY CHARACTERISTICS					
I <sub>F(AV)</sub>	10 A				
$V_{R}$	650 V				
V <sub>F</sub> at I <sub>F</sub> at 25 °C, typ.	1.3 V				
T <sub>J</sub> max.	175 °C				
I <sub>R</sub> at V <sub>R</sub> at 175 °C	50 μA				
$Q_{C} (V_{R} = 400 V)$	27 nC				
Package	D <sup>2</sup> PAK 2L (TO-263AB 2L)				
Circuit configuration	Single				

#### **FEATURES**

Positive V<sub>F</sub> temperature coefficient for easy paralleling



• Virtually no recovery tail and no switching losses

\_\_\_\_\_

COMPLIANT HALOGEN FREE

- Temperature invariant switching behavior
- 175 °C maximum operating junction temperature
- Meets MSL level 1, per J-STD-020, LF maximum peak of 245 °C
- AEC-Q101 qualified, meets JESD 201 class 2 whisker test
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

#### **DESCRIPTION / APPLICATIONS**

Wide band gap SiC based 650 V Schottky diode, designed for high performance and ruggedness.

Optimized for extreme high-speed hard switching across a wide temperature range. This SiC diode is ideal for demanding applications such as high efficiency PFC diodes and ultra-high frequency output rectifiers in AC/DC and DC/DC converters.

#### **MECHANICAL DATA**

Case: D<sup>2</sup>PAK 2L (TO-263AB 2L)

Molding compound meets UL 94 V-0 flammability rating Base P/N-HM3 - halogen-free, RoHS-compliant, and AEC-Q101 gualified

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

MAXIMUM RATINGS (T <sub>A</sub> = 25 °C unless otherwise specified)						
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS		
Peak repetitive reverse voltage	$V_{RRM}$		650	V		
Continuous forward current	I <sub>F</sub> <sup>(1)</sup>	$T_C = 145  ^{\circ}C  (DC)$	10	Α		
Continuous forward current	I <sub>F</sub> <sup>(2)</sup>	$T_C = 138 ^{\circ}C (DC)$	10	Α		
DC blocking voltage	$V_{DC}$		650	V		
Repetitive peak forward current		$T_C$ = 25 °C, f = 50 Hz, square wave, DC = 25 %	42			
Non-months.	I <sub>FSM</sub>	$T_C = 25$ °C, $t_p = 10$ ms, half sine wave	60	A		
Non-repetitive peak forward surge current		$T_C = 110  ^{\circ}\text{C}$ , $t_p = 10  \text{ms}$ , half sine wave	48			
	P <sub>tot</sub> (1)	$T_C = 25  ^{\circ}C$	79 W			
Dower dissination		T <sub>C</sub> = 110 °C	34	] <sup>vv</sup>		
Power dissipation	P <sub>tot</sub> (2)	$T_C = 25  ^{\circ}C$	62.5	w		
		T <sub>C</sub> = 110 °C	27			
124	∫i <sup>2</sup> dt	T <sub>C</sub> = 25 °C	18	A2-		
I <sup>2</sup> t value		T <sub>C</sub> = 110 °C	11.5	A <sup>2</sup> s		
Operating junction and storage temperatures	T <sub>J</sub> <sup>(2)</sup> , T <sub>Stg</sub>		-55 to +175	°C		

#### Notes

- (1) Based on typical R<sub>th</sub>
- (2) Based on maximum R<sub>th</sub>
- (3) The heat generated must be less than the thermal conductivity from junction-to-ambient: dPp/dTJ < 1/ReJA



<b>ELECTRICAL SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	IBOL TEST CONDITIONS		TYP.	MAX.	UNITS	
		I <sub>F</sub> = 10 A	-	1.3	1.5		
Forward voltage	V <sub>F</sub>	I <sub>F</sub> = 10 A, T <sub>J</sub> = 150 °C	-	1.45	1.75	٧	
		I <sub>F</sub> = 10 A, T <sub>J</sub> = 175 °C	-	1.55	-		
Reverse leakage current	I <sub>R</sub>	$V_R = V_R$ rated	-	2	80	μА	
		$V_R = V_R$ rated, $T_J = 150$ °C	-	23	160		
		V <sub>R</sub> = V <sub>R</sub> rated, T <sub>J</sub> = 175 °C	-	50	-		
Total capacitance	С	V <sub>R</sub> = 1 V, f = 1 MHz	-	440	-	pF	
		V <sub>R</sub> = 400 V, f = 1 MHz	-	38	-	PΓ	
Total capacitive charge	Q <sub>C</sub>	V <sub>R</sub> = 400 V, f = 1 MHz	-	27	-	nC	

THERMAL AND MECHANICAL SPECIFICATIONS (T <sub>A</sub> = 25 °C unless otherwise specified)							
PARAMETER	PARAMETER SYMBOL TEST CONDITIONS MIN. TYP. MAX. UNITS						
Thermal resistance, junction to case	R <sub>thJC</sub>		-	1.9	2.4	°C/W	
Marking device	4C10ET07S						

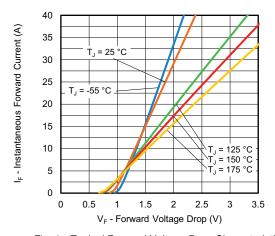


Fig. 1 - Typical Forward Voltage Drop Characteristics

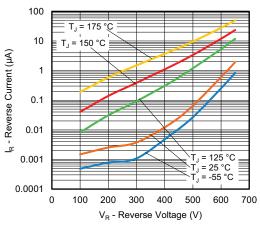


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

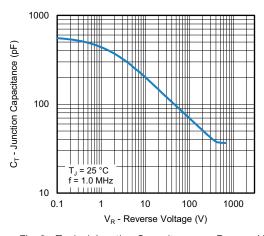


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

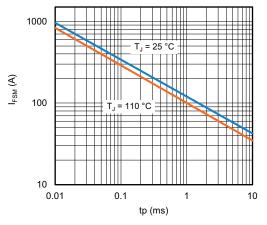


Fig. 4 - Non-Repetitive Peak Forward Surge Current vs. Pulse Duration (Square Wave)

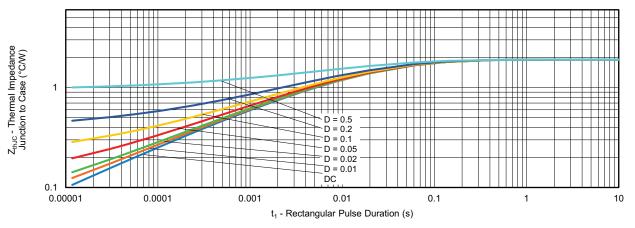


Fig. 5 - Typical Thermal Impedance  $Z_{thJC}$  Characteristics

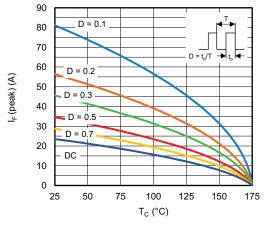


Fig. 6 - Peak Forward Current vs. Maximum Allowable Case Temperature

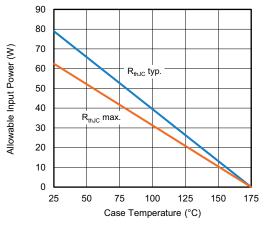


Fig. 7 - Forward Power Loss Characteristics

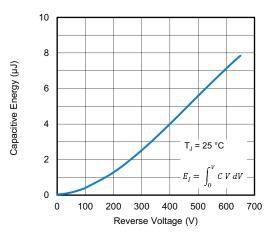


Fig. 8 - Typical Capacitive Energy vs. Reverse Voltage

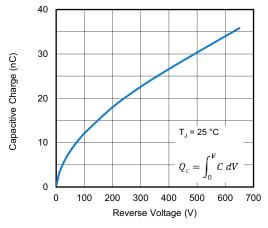
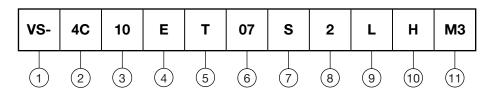


Fig. 9 - Typical Capacitive Charge vs. Reverse Voltage



### **ORDERING INFORMATION TABLE**

**Device code** 



1 - Vishay Semiconductors product

**2** - 4C = SiC diode, generation 4

3 - Current rating (10 = 10 A)

4 - E = single diode

5 - T = D<sup>2</sup>PAK package

6 - Voltage rating: (07 = 650 V)

7 - S = surface mountable

9 - L = tape and reel (left oriented)

**10** - H = AEC-Q101 qualified

11 - Environmental digit:

M3 = halogen-free, RoHS-compliant, and termination lead (Pb)-free

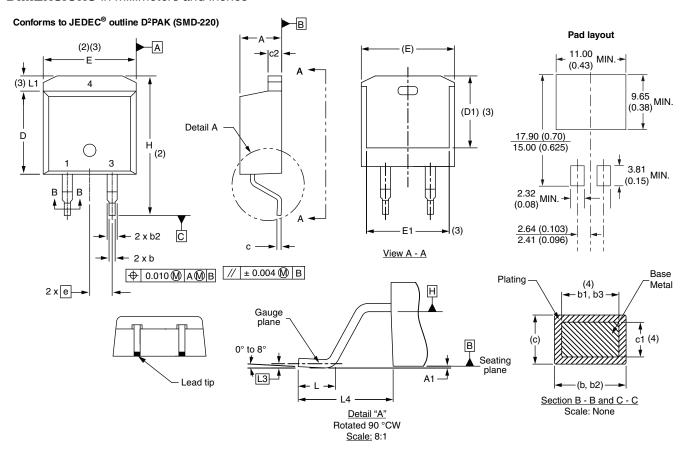
ORDERING INFORMATION							
PREFERRED P/N	UNIT WEIGHT	BASE QUANTITY	PACKAGING DESCRIPTION				
VS-4C10ET07S2LHM3	2 g	800 per reel	13" diameter reel				

LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?96683			
Part marking information	www.vishay.com/doc?96693			
Packaging information	www.vishay.com/doc?95032			



# **D<sup>2</sup>PAK 2L (TO-263AB 2L)**

### **DIMENSIONS** in millimeters and inches



SYMBOL	MILLIM	MILLIMETERS		INCHES		
STIVIBUL	MIN.	MAX.	MIN.	MAX.	NOTES	
Α	4.06	4.83	0.160	0.190		
A1	0.00	0.254	0.000	0.010		
b	0.51	0.99	0.020	0.039		
b1	0.51	0.89	0.020	0.035	4	
b2	1.14	1.78	0.045	0.070		
b3	1.14	1.73	0.045	0.068	4	
С	0.38	0.74	0.015	0.029		
c1	0.38	0.58	0.015	0.023	4	
c2	1.14	1.65	0.045	0.065		
D	8.51	9.65	0.335	0.380	2	

SYMBOL	MILLIMETERS		INC	NOTES	
STWIBOL	MIN.	MAX.	MIN.	MAX.	NOTES
D1	6.86	8.00	0.270	0.315	3
E	9.65	10.67	0.380	0.420	2, 3
E1	7.90	8.80	0.311	0.346	3
е	2.54 BSC		0.100 BSC		
Н	14.61	15.88	0.575	0.625	
L	1.78	2.79	0.070	0.110	
L1	-	1.65	-	0.066	3
L3	0.25 BSC		0.010	BSC	
L4	4.78	5.28	0.188	0.208	

### Notes

- (1) Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Datum A and B to be determined at datum plane H
- (6) Controlling dimension: inch
- (7) Outline conforms to JEDEC® outline TO-263AB



## **Legal Disclaimer Notice**

Vishay

## **Disclaimer**

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Vishay products are not designed for use in life-saving or life-sustaining applications or any application in which the failure of the Vishay product could result in personal injury or death unless specifically qualified in writing by Vishay. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.